#### In-Vehicle IP65-rated Box Computer

# **MVS 5600-IP**



## **Main Features**

- IP65-rated Rugged Design
- Intel<sup>®</sup> Core<sup>™</sup> dual core i7-6600U/i3-6100U (Skylake)
- 9~36VDC with Ignition Control
- Built-in GPS with optional Dead Reckoning
- Up to 2WLAN or two 3G/LTE via 4 mini-PCIe slots
- Electrical Isolation for CAN2.0B & GPI/O
- Optional OBD function (SAE J1939/J1708)
- Rich and various GbE, USB2.0/3.0, Serial I/O and Storages
- Compliant to E-mark and ISO 7637-2
- Compliant to MIL-STD-810G in Vibration/Shock

## **Product Overview**

MVS 5600-IP, an IP65-rated rugged enclosure, maintenance-free box computer, is ideal for data acquisition in extreme environments throughout a number of in-vehicle applications, like transportation, heavy duty and waste management, etc. All external interfaces, including Gigabit Ethernet, isolated CAN bus and digit I/O, USB, and RS232/485 serial ports, are implemented on IP67-proof connectors for reliable data transmission in harsh and rugged environments.

MVS 5600-IP is a modular design, it is flexible to use other kinds of expansion boards to extend different I/O functions for quickly tailored to a vast number of applications. Inside the system, there're four mini-PCIe slots with three SIM card slots offering WLAN, 3G/LTE cat.12, CAN OBD (SAE J1708/J1939) or CVBS functionality. Besides, it can operate at temperatures from -30°C to +60°C under fanless.

MVS 5600-IP supports 9~36VDC power input with ignition managemnt and 12VDC at 2A maximun power output. It is compliant to E-mark and ISO 7637-2 in vehicle certificate and meet US military MIL-STD-810G, composite wheeled vehicle, for vibration and shock criteria.

## **Specifications**

#### CPU

- 6th generation Intel<sup>®</sup> Core™ dual core i7-6600U, 3.4GHz/i3-6100U, 2.3GHz
- Memory
- 204-pin DDR3L SO-DMIM socket support 1600MHz up to 16GB
- 2GB industrial grade memory in default

#### Storage

- 1 x 2.5" SATA 3.0 SSD/HDD
- 1 x CFast (externally acessible)

#### Expansion

- 1 x full size mini-PCIe socket (USB 3.0/2.0)
- 1 x full size mini-PCIe socket (USB 2.0)
- 1 x full size mini-PCIe socket (USB 2.0 + PCIe)
   1 x half size spini PCIe
- 1 x half size mini-PCIe socket (USB 2.0 + PCIe)

### GPS and On Board Sensor

- 1 x default U-blox NEO-M8N GNSS module for GPS/Gloness/QZSS/ Galileo/Beidou
- Optional modules with Dead Reckoning available

#### Built-in G-sensor

#### Ethernet

- 2-port 10/100/1000 Mbps
- Controller: Intel® 1210-T1

#### **Security** • TPM in option

- I/O Interface-Front
- 6 x LED indicators for power/storage/WLAN/WWAN/Status/Health
- 1 x USB type A USB 3.0 port (w/ lid)
  1 x SIM slot (w/ lid)
- 1 x SIM slot (W) (Id)
   1 x Mic-in, 1 x Line-out, power & reset buttons for M12 connector
- 3 x antenna holes for WWAN/GPS
- One expansion port (M12-type) reserved

## I/O Interface-Rear

- Circular 22-pin:
  - 3 x RS-232 (two for full, RI/5V/12V selectable)
- M12 8-pin:
- 1 x GbE
- M12 8-pin:
- 2 x USB 2.0
- M12 12-pin:
- 3-bit GPO & 3-bit GPI
- iButton
- M12 12-pin:
- 1 x Line-out





- DC12V-out, 2A max.
- OBD from optional VIOB-CAN-05/06 module (SAE J1708/J1939)
   2 x CAN Bus 2.0B from optional VIOB-CAN-04 module
- Circular 31-pin:
  - 1 x VGA, resolution up to 2560 x 1600 @60Hz
  - 1 x GbE
  - 2 x RS-485 (2-wire)
  - 1 x CAN 2.0B w/ isolation
- M12 S-code:
- DC 9~36V input with ignition and 40W typical power consumption
- 6-bit DIP switch (w/ lid)
  - 3 x Digital inputs
  - Source-type: 9~36V-in (default)Eexternal-type: 0~33VDC pull-high
  - Isolation
  - 3 x Digital outputs
  - Source-type: 9~36V-in (norminal 35mA@24V) (default)
  - External 5~27VDC pull-high, sink current: typical 220mA for each bit, 500mA max (@25°C)
  - Isolation
  - Source or external selected by 6-bit DIP Switch
- 1 x SIM card socket (w/ lid) and 1x internal SIM card socket selectable
- 4 x antenna holes for WLAN/WWAN
- 1 x M12 S-code for 9~36VDC-IN

#### Power Management

• Selectable boot-up & shut-down voltage for low power protection by software. Setting 8-level power on/ off delay time by software. Support S3/S4 suspend mode

#### **Operating System**

• Windows 7/WES7/Windows 8/WES8/Windows 10/Linux kernel 3.X

#### Dimensions

• 260mm (W) x 196mm (D) x 66.5mm (H) (10.24" x 7.72" x 2.62")

## • 3.3kg

- Environment
- Operating temperatures:
- -30°C~60°C (w/ industrial SSD) with air flow
- Storage temperatures: -40°C~80°C
  Relative humidity: 10% to 90% (non-condensing)
- Vibration (random):
- 1.5g@5~500 Hz (in operation, HDD), 2g@5~500 Hz (in operation, SSD)
- Vibration (SSD):
- Operating: MIL-STD-810G, 514.6C, Category 4
- Storage: MIL-STD-810G, 514.6, Category 24, minimum integrity test
- Shock (SSD/HDD):
- Operating: MIL-STD-810G, Method 516.6, Procedure I, functional shock=20g
- Non-operating: MIL-STD-810G, Method 516.6, Procedure V, crash hazard shock test=75g

#### Certifications

• CE approval, FCC Class A, E13

## **Ordering Information**

#### MVS 5600-3IPK (P/N: 10VS0560005X0)

Intel® Core™ 2c i3-6100U (Skylake) 2.3GHz, 2GB DDR3L industrial grade, 2 x GbE, VGA output, 3 x RS-232, 2 x RS-485, 2 x USB2.0, 1 x USB3.0, 12VDC output, 1 x CAN 2.0B

- MVS 5600-7IPK (P/N: 10VS0560004X0)
   Intel® Core™ 2c i7-6600U (Skylake) 3.4GHz, 2GB DDR3L industrial grade, 2 x GbE, VGA output, 3 x RS-232, 2 x RS-485, 2 x USB2.0, 1 x USB3.0, 12VDC output, 1 x CAN 2.0BOrdering Information
- Cable Kit (P/N: 10VS0262001X0)
   External cables for all the communication ports

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